	© Cop	terial Compo pyright 2005. IPC, Bannoc Iternational and Pan-Americ	kburn, Illinois	. All rights reserv	tion with lower	level pa	arts, the	declaratio	n encon		ver level mate	erials for	which t	e item is an assembly he manufacturer has declaration.	
1/32-2 1.1		Neb Site for Informat	-1752 Standa	rd					ration Class * 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informat						
Supplier Information															
Company Name * Company Unique ID				Unique ID Au	Response Date *				Response Do						
SEMTECH CORPORATIO	00-847-9941		DUNS		2016-07-18										
Contact Name * Roya Motamedi		Title - Contact Supervisor, QA Prod	uct Suppor	Phone - Con 805-498-211	Email - Contact * rmotamedi@semtech.com			com	Duplicate Contact -> Authorized Representative						
Authorized Representativ Roya Motamedi	Title - Representative Supervisor, QA Prod	Representative Phone - Re isor, QA Product Suppo 805-498-21			Email - Representative * rmotamedi@semtech.com				Supplier Com	ments or URI	_ for Add	litional li	nformation		
Requester Item Number		Mfr Item Number		Mfr Item Name	Effective	e Date	Version Manufa		cturing Site	Weight *	UOM		Unit Type		
	SC2599ULTRC			Low Voltage DDR Termination			R M			ia	7.87	mg		Each	
Alternate Recommenda	ndation				Alternate Item 0			Item Co	mments						
Manufacturing Proces	s Inf	formation													
Terminal Plating / Grid Array N	Materi	al	Terminal Ba	ase Alloy	J-STD-020 MSL Ra	ating F	Peak Proc	ess Body	Tempera	ature Max Tim	e at Peak Tem	perature	Number	of Reflow Cycles	
Matte Tin (Sn) CU Alloy Comments				1				260 C		30 se	econds	3			
SC2599ULTRC is REACH	H-cor	mpliant product, per	r EU Regu	lation EC190	7/2006 to include	e recent	addition	n of SVH	IC cand	idate list of s	substances i	n June 2	2016.		

Save the fields in this form to a file	Evport Data	Import fields from a file into this form	Import Data	Clear all of the fields on this form	Reset Form	Lock the fields on this form to prevent chan	Look Cupplier Fields				
RoHS Material Composition Declaration Declaration Declaration Type * Detailed											
		ty limit of 0.1% by mass (100 Ethers (PBDE) and quantity					ominated Biphenyls (PBB),				
chromium, polybromina excess of an applicable gathered the information Company will rely on thi completing this form, ar certifications regarding conditions of that agree	ted biphenyls and/or polybrominate quantity limit, please indicate below it provides in this form using app s certification in determining the co d that Supplier may not have inde heir contributions to the part, and ment, including any warranty rights	ompliance of its products with European pendently verified such information. Ho those certifications are at least as comp	ricted substance?) in excess believe may apply. If the p y and that such information n Union member state laws owever, in situations where prehensive as the certificati hat agreement, will be the s	ss of the applicable quantity lim part is an assembly with lower I is true and correct to the best of that implement the RoHS Dire Supplier has not independently ion in this paragraph. If the Co sole and exclusive source of the	it identified above. If a homoge evel components, the declaration of its knowledge and belief, as of ctive. Company acknowledges y verified information provided lo popany and the Supplier enter is a Supplier?s liability and the Co	eneous material within the part cor on shall encompass all such comp of the date that Supplier complete: s that Supplier may have relied on by others, Supplier agrees that, at into a written agreement with resp impany?s remedies for issues that	ntains a RoHS restricted substance in ponents. Supplier certifies that it s this form. Supplier acknowledges that information provided by others in a minimum, its suppliers have provided				
RoHS Declaration	n * 1 - Item(s) does not conta	ain RoHS restricted substances per the	he definition above			Supplier Acceptance *	Accepted				
	e declared item does not co all applicable exemptions.	ntain RoHS restricted substanc	es per the definition a	above except for defined	RoHS exemptions, then	select the corresponding re	esponse in the RoHS Declaration				
Declaration S	ignature										
In a family of the second	ward a factor and the factor of the second s	al Calaba and all manages of the last		a second se	• • • • •	and the second s	terrestring and - Distingthe stars				

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem		Homogeneous	Weight	Unit of		Level	Substance Category			Substance	CAS	Exempt	Weight	Unit of Measure	Tolerance		PPM
	Name		Material	Weight	Measure			oubstance outegory				UNU	Exempt			-	+	
+I	-I Lead frame	+M -N	C7025 AgCu	3.78	mg	+C -C	Supplier		+S	-S	Copper	7440-50-8	-	3.65	mg		ŕ	463,92
									+S	-s	Iron	7439-89-6		0.085	mg			10,836
						+C -C	A	Lead/Lead Compound	+S	-s	Lead	7439-92-1		0	mg			14
						+C -C	Supplier		+S	-S	Phophorus	7723-14-0		0.001	mg			115
									+S	-s	Zinc	7440-66-6		0.005	mg			610
									+S	-s	Silver	7440-22-4		0.038	mg			4,803
+I	-I Die	+M -N	Silicon Chip	0.18	mg	+C -C	Supplier		+S	-S	Si	7440-21-3		0.18	mg		:	22,871
+I	-I Die attachmaterial	+M -N	1 QMI519	0.13	mg	+C -C	Supplier		+S	-S	Silver	7440-22-4		0.1	mg			13,297
									+S	-s	Carbocyclic Acrylate	Proprietary		0.01	mg			1,651.8
									+S	-s	Bismaleimide resin	Proprietary		0.004	mg			495.55
									+S	-s	2-preponoic acid, 2-met	68586-19-6		0.004	mg			495.55
									+S	-s	Additive	Proprietary		0.004	mg			495.55
									+S	-s	Dicumlyl peroxide	80-43-3		0.001	mg			82.59
+I	-I Wire	+M -N	Copper (Pd coat	te0.16	mg	+C -C	Supplier		+S	-S	Cu	7440-50-8		0.16	mg			19,974
									+S	-S	Pd	7440-05-3		0.0028	mg			355.78
+I	-I Encapsulation	+M -N	EME-G770HCD	3.44	mg	+C -C	Supplier		+S	-S	Silica Fused	60676-86-0		3.22	mg		·	409,56
									+S	-S	Epoxy resin	Proprietary		0.1	mg			13,113
									+S	-S	Phenol resin	Proprietary		0.1	mg			13,113
									+S	-s	Carbon black	1333-86-4		0.01	mg			1,311.3
+I	-I Lead finish	+M -N	Tin alloy	0.18	mg	+C -C	Supplier		+S	-S	Tin	7440-31-5		0.18	mg			22,871